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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Obsolete
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	82
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	20K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 20x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f100pjafb-v0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f100pjafb-v0</a>

Table 1-1. List of Ordering Part Numbers

(6/12)

Pin count	Package	Data flash	Fields of Application <small>Note</small>	Ordering Part Number
48 pins	48-pin plastic HWQFN (7 × 7 mm, 0.5 mm pitch)	Mounted	A D G	R5F100GAANA#U0, R5F100GCANA#U0, R5F100GDANA#U0, R5F100GEANA#U0, R5F100GFANA#U0, R5F100GGANA#U0, R5F100GHANA#U0, R5F100GJANA#U0, R5F100GKANA#U0, R5F100GLANA#U0 R5F100GAANA#W0, R5F100GCANA#W0, R5F100GDANA#W0, R5F100GEANA#W0, R5F100GFANA#W0, R5F100GGANA#W0, R5F100GHANA#W0, R5F100GJANA#W0, R5F100GKANA#W0, R5F100GLANA#W0 R5F100GADNA#U0, R5F100GCDNA#U0, R5F100GDDNA#U0, R5F100GEDNA#U0, R5F100GFDNA#U0, R5F100GGDNA#U0, R5F100GHDNA#U0, R5F100GJDNA#U0, R5F100GKDNA#U0, R5F100GLDNA#U0 R5F100GADNA#W0, R5F100GCDNA#W0, R5F100GDDNA#W0, R5F100GEDNA#W0, R5F100GFDNA#W0, R5F100GGDNA#W0, R5F100GHDNA#W0, R5F100GJDNA#W0, R5F100GKDNA#W0, R5F100GLDNA#W0 R5F100GAGNA#U0, R5F100GCGNA#U0, R5F100GDGNA#U0, R5F100GEGNA#U0, R5F100GFGNA#U0, R5F100GGGNA#U0, R5F100GHGNA#U0, R5F100GJGNA#U0 R5F100GAGNA#W0, R5F100GCGNA#W0, R5F100GDGNA#W0, R5F100GEGNA#W0, R5F100GFGNA#W0, R5F100GGGNA#W0, R5F100GHGNA#W0, R5F100GJGNA#W0
	Not mounted	A D		R5F101GAANA#U0, R5F101GCANA#U0, R5F101GDANA#U0, R5F101GEANA#U0, R5F101GFANA#U0, R5F101GGANA#U0, R5F101GHANA#U0, R5F101GJANA#U0, R5F101GKANA#U0, R5F101GLANA#U0 R5F101GAANA#W0, R5F101GCANA#W0, R5F101GDANA#W0, R5F101GEANA#W0, R5F101GFANA#W0, R5F101GGANA#W0, R5F101GHANA#W0, R5F101GJANA#W0, R5F101GKANA#W0, R5F101GLANA#W0 R5F101GADNA#U0, R5F101GCDNA#U0, R5F101GDDNA#U0, R5F101GEDNA#U0, R5F101GFDNA#U0, R5F101GGDNA#U0, R5F101GHDNA#U0, R5F101GJDNA#U0, R5F101GKDNA#U0, R5F101GLDNA#U0 R5F101GADNA#W0, R5F101GCDNA#W0, R5F101GDDNA#W0, R5F101GEDNA#W0, R5F101GFDNA#W0, R5F101GGDNA#W0, R5F101GHDNA#W0, R5F101GJDNA#W0, R5F101GKDNA#W0, R5F101GLDNA#W0

**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

**Caution** The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

Table 1-1. List of Ordering Part Numbers

(10/12)

Pin count	Package	Data flash	Fields of Application <small>Note</small>	Ordering Part Number
80 pins	80-pin plastic LQFP (14 × 14 mm, 0.65 mm pitch)	Mounted	A	R5F100MFAFA#V0, R5F100MGAFA#V0, R5F100MHAFA#V0, R5F100MJAFA#V0, R5F100MKAFA#V0, R5F100MLAFA#V0 R5F100MFAFA#X0, R5F100MGAFA#X0, R5F100MHAFA#X0, R5F100MJAFA#X0, R5F100MKAFA#X0, R5F100MLAFA#X0 R5F100MF DFA#V0, R5F100MG DFA#V0, R5F100MH DFA#V0, R5F100MJD FA#V0, R5F100MK DFA#V0, R5F100MLD FA#V0 R5F100MF DFA#X0, R5F100MG DFA#X0, R5F100MH DFA#X0, R5F100MJD FA#X0, R5F100MK DFA#X0, R5F100MLD FA#X0 R5F100MFG FA#V0, R5F100MGG FA#V0, R5F100MHG FA#V0, R5F100MJG FA#V0 R5F100MFG FA#X0, R5F100MGG FA#X0, R5F100MHG FA#X0, R5F100MJG FA#X0
			D	R5F100MF DFA#V0, R5F100MG DFA#V0, R5F100MH DFA#V0, R5F100MJD FA#V0, R5F100MK DFA#V0, R5F100MLD FA#V0 R5F100MF DFA#X0, R5F100MG DFA#X0, R5F100MH DFA#X0, R5F100MJD FA#X0, R5F100MK DFA#X0, R5F100MLD FA#X0 R5F100MFG FA#V0, R5F100MGG FA#V0, R5F100MHG FA#V0, R5F100MJG FA#V0 R5F100MFG FA#X0, R5F100MGG FA#X0, R5F100MHG FA#X0, R5F100MJG FA#X0
			G	R5F101MFAFA#V0, R5F101MGAFA#V0, R5F101MHAFA#V0, R5F101MJAFA#V0, R5F101MKAFA#V0, R5F101MLAFA#V0 R5F101MFAFA#X0, R5F101MGAFA#X0, R5F101MHAFA#X0, R5F101MJAFA#X0, R5F101MKAFA#X0, R5F101MLAFA#X0 R5F101MF DFA#V0, R5F101MG DFA#V0, R5F101MH DFA#V0, R5F101MJD FA#V0, R5F101MK DFA#V0, R5F101MLD FA#V0 R5F101MF DFA#X0, R5F101MG DFA#X0, R5F101MH DFA#X0, R5F101MJD FA#X0, R5F101MK DFA#X0, R5F101MLD FA#X0 R5F101MFG FA#V0, R5F101MGG FA#V0, R5F101MHG FA#V0, R5F101MJG FA#V0 R5F101MFG FA#X0, R5F101MGG FA#X0, R5F101MHG FA#X0, R5F101MJG FA#X0
		Not mounted	A	R5F101MFAFB#V0, R5F100MGAFB#V0, R5F100MHAFB#V0, R5F100MJAFB#V0, R5F100MKAFB#V0, R5F100MLAFB#V0 R5F100MFAFB#X0, R5F100MGAFB#X0, R5F100MHAFB#X0, R5F100MJAFB#X0, R5F100MKAFB#X0, R5F100MLAFB#X0 R5F100MF DFB#V0, R5F100MG DFB#V0, R5F100MH DFB#V0, R5F100MJD FB#V0, R5F100MK DFB#V0, R5F100MLD FB#V0 R5F100MF DFB#X0, R5F100MG DFB#X0, R5F100MH DFB#X0, R5F100MJD FB#X0, R5F100MK DFB#X0, R5F100MLD FB#X0 R5F100MFG FB#V0, R5F100MGG FB#V0, R5F100MHG FB#V0, R5F100MJG FB#V0 R5F100MFG FB#X0, R5F100MGG FB#X0, R5F100MHG FB#X0, R5F100MJG FB#X0
	80-pin plastic LFQFP (12 × 12 mm, 0.5 mm pitch)	Mounted	A	R5F100MFAFB#V0, R5F100MGAFB#V0, R5F100MHAFB#V0, R5F100MJAFB#V0, R5F100MKAFB#V0, R5F100MLAFB#V0 R5F100MFAFB#X0, R5F100MGAFB#X0, R5F100MHAFB#X0, R5F100MJAFB#X0, R5F100MKAFB#X0, R5F100MLAFB#X0 R5F100MF DFB#V0, R5F100MG DFB#V0, R5F100MH DFB#V0, R5F100MJD FB#V0, R5F100MK DFB#V0, R5F100MLD FB#V0 R5F100MF DFB#X0, R5F100MG DFB#X0, R5F100MH DFB#X0, R5F100MJD FB#X0, R5F100MK DFB#X0, R5F100MLD FB#X0 R5F100MFG FB#V0, R5F100MGG FB#V0, R5F100MHG FB#V0, R5F100MJG FB#V0 R5F100MFG FB#X0, R5F100MGG FB#X0, R5F100MHG FB#X0, R5F100MJG FB#X0
			D	R5F100MFAFB#V0, R5F100MGAFB#V0, R5F100MHAFB#V0, R5F100MJAFB#V0, R5F100MKAFB#V0, R5F100MLAFB#V0 R5F100MFAFB#X0, R5F100MGAFB#X0, R5F100MHAFB#X0, R5F100MJAFB#X0, R5F100MKAFB#X0, R5F100MLAFB#X0 R5F100MF DFB#V0, R5F100MG DFB#V0, R5F100MH DFB#V0, R5F100MJD FB#V0, R5F100MK DFB#V0, R5F100MLD FB#V0 R5F100MF DFB#X0, R5F100MG DFB#X0, R5F100MH DFB#X0, R5F100MJD FB#X0, R5F100MK DFB#X0, R5F100MLD FB#X0 R5F100MFG FB#V0, R5F100MGG FB#V0, R5F100MHG FB#V0, R5F100MJG FB#V0 R5F100MFG FB#X0, R5F100MGG FB#X0, R5F100MHG FB#X0, R5F100MJG FB#X0
			G	R5F101MFAFB#V0, R5F101MGAFB#V0, R5F101MHAFB#V0, R5F101MJAFB#V0, R5F101MKAFB#V0, R5F101MLAFB#V0 R5F101MFAFB#X0, R5F101MGAFB#X0, R5F101MHAFB#X0, R5F101MJAFB#X0, R5F101MKAFB#X0, R5F101MLAFB#X0 R5F101MF DFB#V0, R5F101MG DFB#V0, R5F101MH DFB#V0, R5F101MJD FB#V0, R5F101MK DFB#V0, R5F101MLD FB#V0 R5F101MF DFB#X0, R5F101MG DFB#X0, R5F101MH DFB#X0, R5F101MJD FB#X0, R5F101MK DFB#X0, R5F101MLD FB#X0 R5F101MFG FB#V0, R5F101MGG FB#V0, R5F101MHG FB#V0, R5F101MJG FB#V0 R5F101MFG FB#X0, R5F101MGG FB#X0, R5F101MHG FB#X0, R5F101MJG FB#X0
		Not mounted	A	R5F101MFAFB#V0, R5F101MGAFB#V0, R5F101MHAFB#V0, R5F101MJAFB#V0, R5F101MKAFB#V0, R5F101MLAFB#V0 R5F101MFAFB#X0, R5F101MGAFB#X0, R5F101MHAFB#X0, R5F101MJAFB#X0, R5F101MKAFB#X0, R5F101MLAFB#X0 R5F101MF DFB#V0, R5F101MG DFB#V0, R5F101MH DFB#V0, R5F101MJD FB#V0, R5F101MK DFB#V0, R5F101MLD FB#V0 R5F101MF DFB#X0, R5F101MG DFB#X0, R5F101MH DFB#X0, R5F101MJD FB#X0, R5F101MK DFB#X0, R5F101MLD FB#X0 R5F101MFG FB#V0, R5F101MGG FB#V0, R5F101MHG FB#V0, R5F101MJG FB#V0 R5F101MFG FB#X0, R5F101MGG FB#X0, R5F101MHG FB#X0, R5F101MJG FB#X0

**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

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**Table 1-1. List of Ordering Part Numbers**

(12/12)

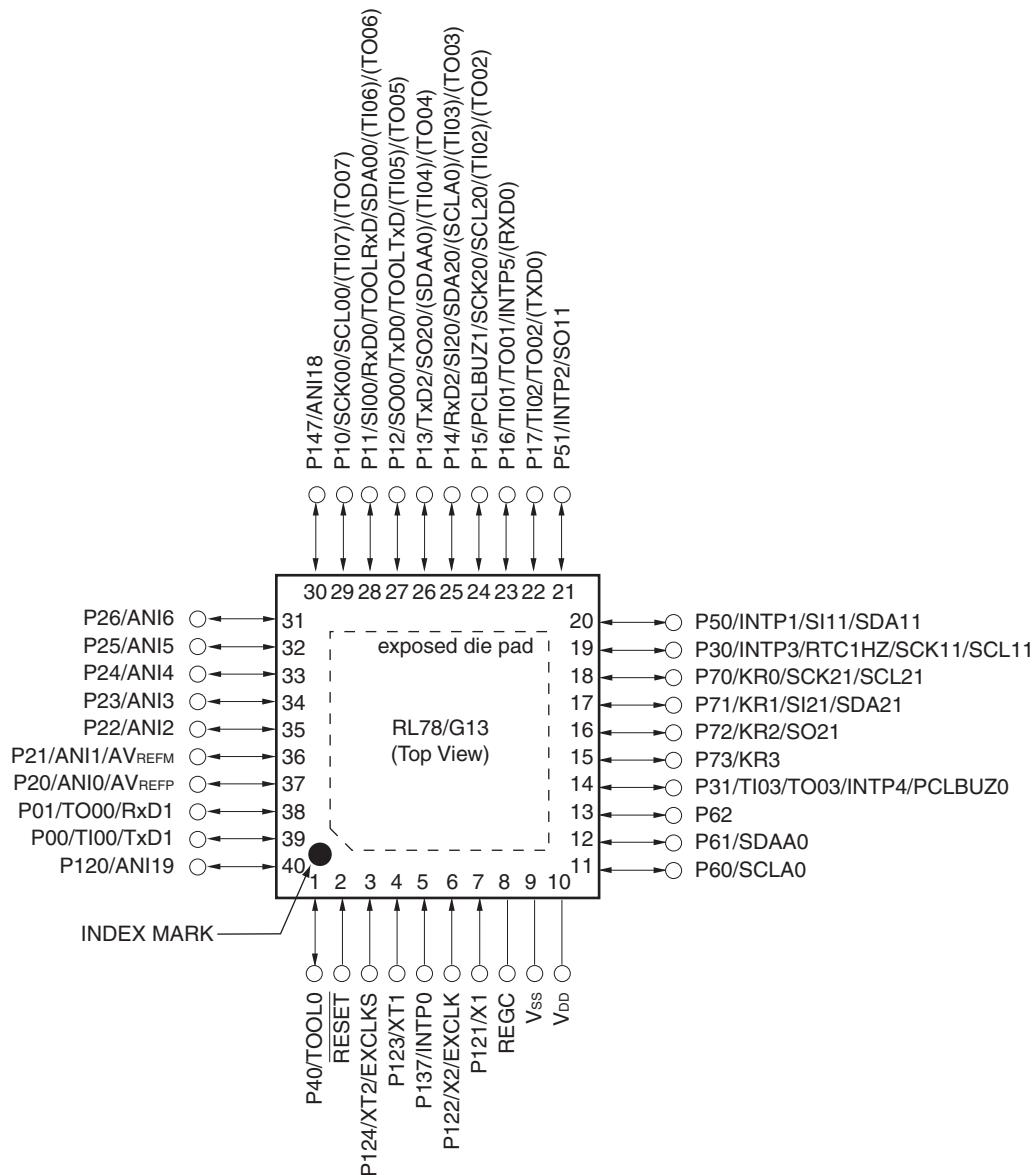
Pin count	Package	Data flash	Fields of Application <sup>Note</sup>	Ordering Part Number
128 pins	128-pin plastic LQFP (14 × 20 mm, 0.5 mm pitch)	Mounted	A	R5F100SHAFB#V0, R5F100SJAFB#V0, R5F100SKAFB#V0, R5F100SLAFB#V0 R5F100SHAFB#X0, R5F100SJAFB#X0, R5F100SKAFB#X0, R5F100SLAFB#X0 R5F100SHDFB#V0, R5F100SJDFB#V0, R5F100SKDFB#V0, R5F100SLDFB#V0 R5F100SHDFB#X0, R5F100SJDFB#X0, R5F100SKDFB#X0, R5F100SLDFB#X0
			D	R5F101SHAFB#V0, R5F101SJAFB#V0, R5F101SKAFB#V0, R5F101SLAFB#V0 R5F101SHAFB#X0, R5F101SJAFB#X0, R5F101SKAFB#X0, R5F101SLAFB#X0 R5F101SHDFB#V0, R5F101SJDFB#V0, R5F101SKDFB#V0, R5F101SLDFB#V0 R5F101SHDFB#X0, R5F101SJDFB#X0, R5F101SKDFB#X0, R5F101SLDFB#X0

**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

**Caution** The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

### 1.3.7 40-pin products

- 40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch)



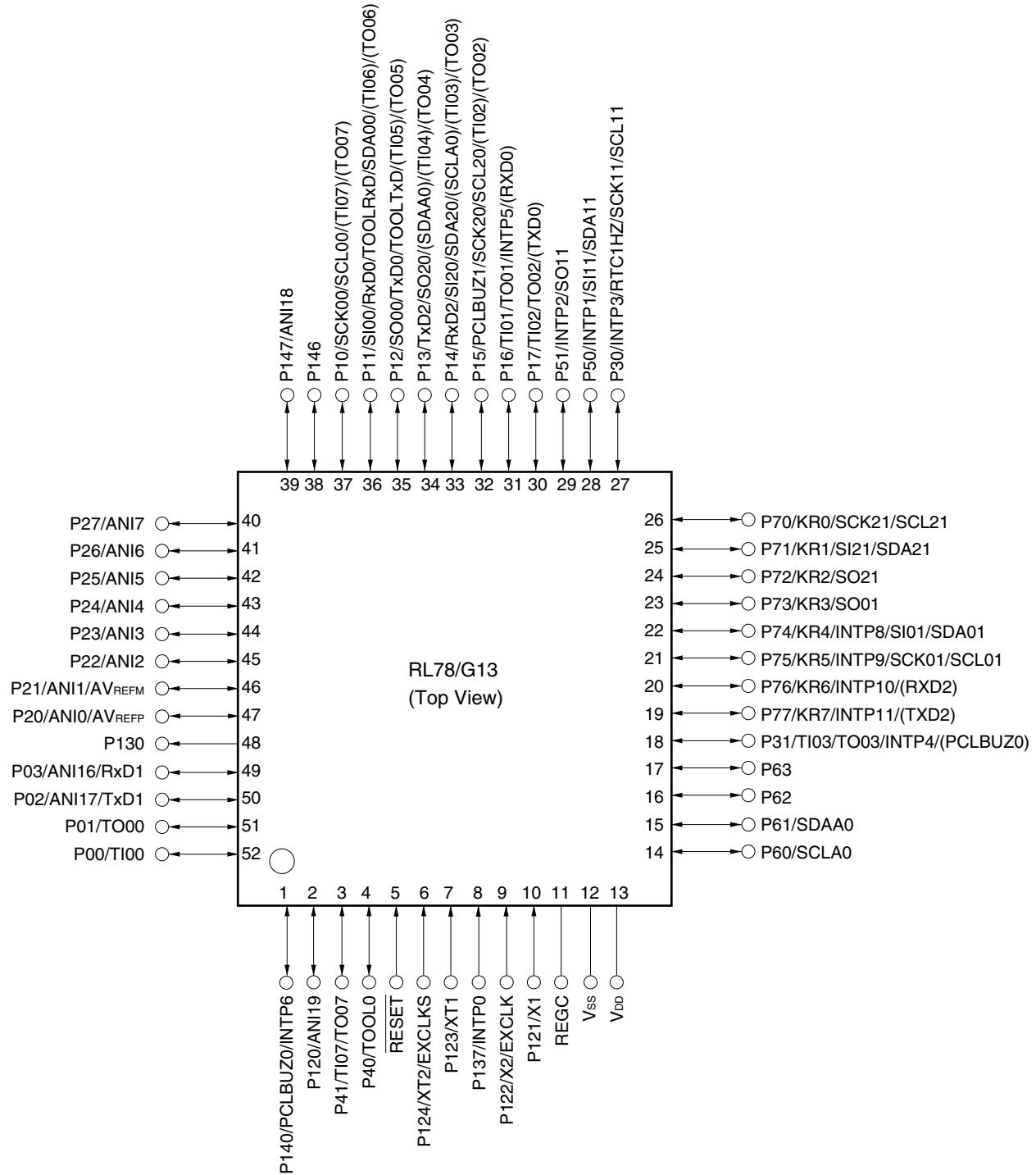
**Caution Connect the REGC pin to V<sub>ss</sub> via a capacitor (0.47 to 1  $\mu$ F).**

**Remarks 1.** For pin identification, see **1.4 Pin Identification**.

2. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.
3. It is recommended to connect an exposed die pad to V<sub>ss</sub>.

### 1.3.10 52-pin products

- 52-pin plastic LQFP (10 × 10 mm, 0.65 mm pitch)

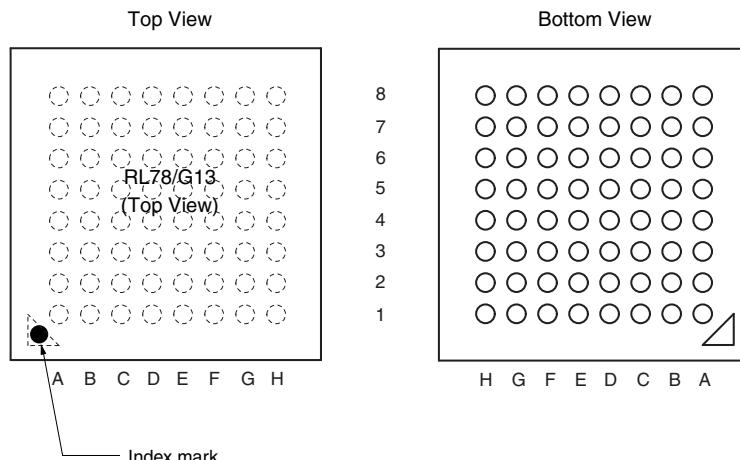


**Caution Connect the REGC pin to V<sub>ss</sub> via a capacitor (0.47 to 1  $\mu$ F).**

**Remarks 1.** For pin identification, see **1.4 Pin Identification**.

2. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

- 64-pin plastic VFBGA (4 × 4 mm, 0.4 mm pitch)



Pin No.	Name	Pin No.	Name	Pin No.	Name	Pin No.	Name
A1	P05/TI05/TO05	C1	P51/INTP2/SO11	E1	P13/TxD2/SO20/(SDAA0)/(TI04)/(TO04)	G1	P146
A2	P30/INTP3/RTC1HZ/SCK11/SCL11	C2	P71/KR1/SI21/SDA21	E2	P14/RxD2/SI20/SDA20/(SCLA0)/(TI03)/(TO03)	G2	P25/ANI5
A3	P70/KR0/SCK21/SCL21	C3	P74/KR4/INTP8/SI01/SDA01	E3	P15/SCK20/SCL20/(TI02)/(TO02)	G3	P24/ANI4
A4	P75/KR5/INTP9/SCK01/SCL01	C4	P52/(INTP10)	E4	P16/TI01/TO01/INTP5/(SI00)/(RxD0)	G4	P22/ANI2
A5	P77/KR7/INTP11/(TxD2)	C5	P53/(INTP11)	E5	P03/ANI16/SI10/RxD1/SDA10	G5	P130
A6	P61/SDAA0	C6	P63	E6	P41/TI07/TO07	G6	P02/ANI17/SO10/TxD1
A7	P60/SCLA0	C7	V <sub>ss</sub>	E7	RESET	G7	P00/TI00
A8	EV <sub>DD0</sub>	C8	P121/X1	E8	P137/INTP0	G8	P124/XT2/EXCLKS
B1	P50/INTP1/SI11/SDA11	D1	P55/(PCLBUZ1)/(SCK00)	F1	P10/SCK00/SCL00/(TI07)/(TO07)	H1	P147/ANI18
B2	P72/KR2/SO21	D2	P06/TI06/TO06	F2	P11/SI00/RxD0/TOOLRxSDA00/(TI06)/(TO06)	H2	P27/ANI7
B3	P73/KR3/SO01	D3	P17/TI02/TO02/(SO00)/(TxD0)	F3	P12/SO00/TxD0/TOOLTxD/(INTP5)/(TI05)/(TO05)	H3	P26/ANI6
B4	P76/KR6/INTP10/(RxD2)	D4	P54	F4	P21/ANI1/AV <sub>REFM</sub>	H4	P23/ANI3
B5	P31/TI03/TO03/INTP4/(PCLBUZ0)	D5	P42/TI04/TO04	F5	P04/SCK10/SCL10	H5	P20/ANI0/AV <sub>REFP</sub>
B6	P62	D6	P40/TOOL0	F6	P43	H6	P141/PCLBUZ1/INTP7
B7	V <sub>DD</sub>	D7	REGC	F7	P01/TO00	H7	P140/PCLBUZ0/INTP6
B8	EV <sub>SS0</sub>	D8	P122/X2/EXCLK	F8	P123/XT1	H8	P120/ANI19

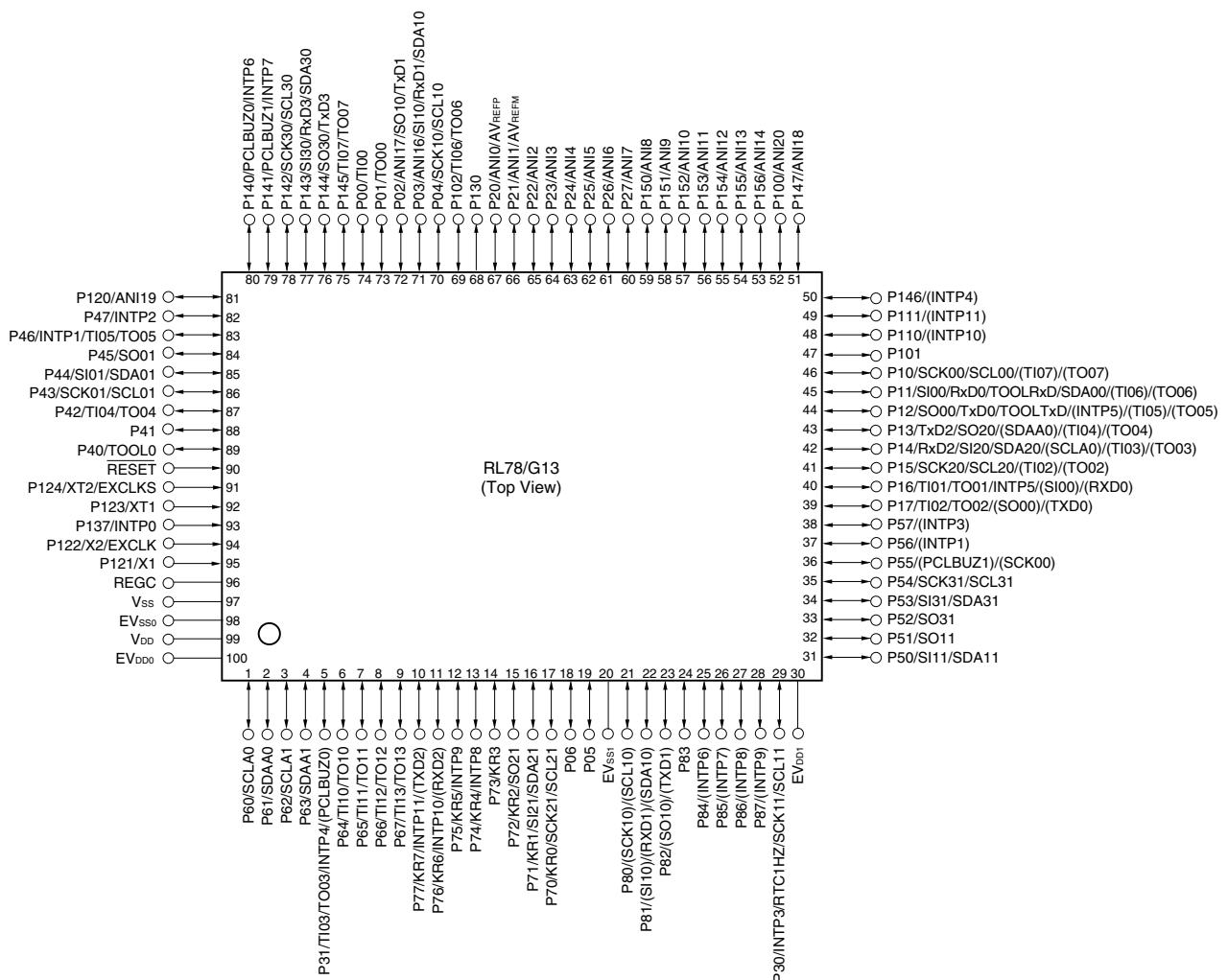
**Cautions** 1. Make EV<sub>SS0</sub> pin the same potential as V<sub>ss</sub> pin.

2. Make V<sub>DD</sub> pin the potential that is higher than EV<sub>DD0</sub> pin.
3. Connect the REGC pin to V<sub>ss</sub> via a capacitor (0.47 to 1  $\mu$ F).

**Remarks** 1. For pin identification, see 1.4 Pin Identification.

2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V<sub>DD</sub> and EV<sub>DD0</sub> pins and connect the V<sub>ss</sub> and EV<sub>SS0</sub> pins to separate ground lines.
3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

- 100-pin plastic LQFP (14 × 20 mm, 0.65 mm pitch)



**Cautions** 1. Make EV<sub>SS0</sub>, EV<sub>SS1</sub> pins the same potential as V<sub>SS</sub> pin.

2. Make V<sub>DD</sub> pin the potential that is higher than EV<sub>DD0</sub>, EV<sub>DD1</sub> pins (EV<sub>DD0</sub> = EV<sub>DD1</sub>).
3. Connect the REGC pin to V<sub>SS</sub> via a capacitor (0.47 to 1  $\mu$ F).

**Remarks** 1. For pin identification, see **1.4 Pin Identification**.

2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V<sub>DD</sub>, EV<sub>DD0</sub> and EV<sub>DD1</sub> pins and connect the V<sub>SS</sub>, EV<sub>SS0</sub> and EV<sub>SS1</sub> pins to separate ground lines.
3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

[40-pin, 44-pin, 48-pin, 52-pin, 64-pin products]

**Caution This outline describes the functions at the time when Peripheral I/O redirection register (PIOR) is set to 00H.**

(1/2)

Item	40-pin		44-pin		48-pin		52-pin		64-pin										
	R5F100Ex	R5F101Ex	R5F100Fx	R5F101Fx	R5F100Gx	R5F101Gx	R5F100Jx	R5F101Jx	R5F100Lx	R5F101Lx									
Code flash memory (KB)	16 to 192		16 to 512		16 to 512		32 to 512		32 to 512										
Data flash memory (KB)	4 to 8	—	4 to 8	—	4 to 8	—	4 to 8	—	4 to 8	—									
RAM (KB)	2 to 16 <sup>Note1</sup>		2 to 32 <sup>Note1</sup>		2 to 32 <sup>Note1</sup>		2 to 32 <sup>Note1</sup>		2 to 32 <sup>Note1</sup>										
Address space	1 MB																		
Main system clock	High-speed system clock	X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (High-speed main) mode: 1 to 20 MHz ( $V_{DD} = 2.7$ to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to 5.5 V)																	
	High-speed on-chip oscillator	HS (High-speed main) mode: 1 to 32 MHz ( $V_{DD} = 2.7$ to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz ( $V_{DD} = 2.4$ to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz ( $V_{DD} = 1.8$ to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz ( $V_{DD} = 1.6$ to 5.5 V)																	
Subsystem clock	XT1 (crystal) oscillation, external subsystem clock input (EXCLKS) 32.768 kHz																		
Low-speed on-chip oscillator	15 kHz (TYP.)																		
General-purpose registers	(8-bit register × 8) × 4 banks																		
Minimum instruction execution time	0.03125 $\mu$ s (High-speed on-chip oscillator: $f_{IH} = 32$ MHz operation) 0.05 $\mu$ s (High-speed system clock: $f_{MX} = 20$ MHz operation) 30.5 $\mu$ s (Subsystem clock: $f_{SUB} = 32.768$ kHz operation)																		
Instruction set	<ul style="list-style-type: none"> <li>Data transfer (8/16 bits)</li> <li>Adder and subtractor/logical operation (8/16 bits)</li> <li>Multiplication (8 bits × 8 bits)</li> <li>Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc.</li> </ul>																		
I/O port	Total	36	40	44	48	58													
	CMOS I/O	28 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 10)	31 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 10)	34 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 11)	38 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 13)	48 (N-ch O.D. I/O [ $V_{DD}$ withstand voltage]: 15)													
	CMOS input	5	5	5	5	5													
	CMOS output	—	—	1	1	1													
	N-ch O.D. I/O (withstand voltage: 6 V)	3	4	4	4	4													
Timer	16-bit timer	8 channels																	
	Watchdog timer	1 channel																	
	Real-time clock (RTC)	1 channel																	
	12-bit interval timer (IT)	1 channel																	
	Timer output	4 channels (PWM outputs: 3 <sup>Note2</sup> ), 8 channels (PWM outputs: 7 <sup>Note2, Note3</sup> )	5 channels (PWM outputs: 4 <sup>Note2</sup> ), 8 channels (PWM outputs: 7 <sup>Note2, Note3</sup> )	8 channels (PWM outputs: 7 <sup>Note2</sup> )															
	RTC output	1 channel • 1 Hz (subsystem clock: $f_{SUB} = 32.768$ kHz)																	

**Notes** 1. The flash library uses RAM in self-programming and rewriting of the data flash memory.  
The target products and start address of the RAM areas used by the flash library are shown below.

R5F100xD, R5F101xD (x = E to G, J, L): Start address FF300H

R5F100xE, R5F101xE (x = E to G, J, L): Start address FEF00H

R5F100xJ, R5F101xJ (x = F, G, J, L): Start address FAF00H

R5F100xL, R5F101xL (x = F, G, J, L): Start address F7F00H

For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.

## 2. ELECTRICAL SPECIFICATIONS ( $T_A = -40$ to $+85^\circ\text{C}$ )

This chapter describes the following electrical specifications.

Target products A: Consumer applications  $T_A = -40$  to  $+85^\circ\text{C}$

R5F100xxAxx, R5F101xxAxx

D: Industrial applications  $T_A = -40$  to  $+85^\circ\text{C}$

R5F100xxDxx, R5F101xxDxx

G: Industrial applications when  $T_A = -40$  to  $+105^\circ\text{C}$  products is used in the range of  $T_A = -40$  to  $+85^\circ\text{C}$

R5F100xxGxx

- Cautions**
1. **The RL78 microcontrollers have an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.**
  2. **With products not provided with an  $\text{EV}_{\text{DD}0}$ ,  $\text{EV}_{\text{DD}1}$ ,  $\text{EV}_{\text{SS}0}$ , or  $\text{EV}_{\text{SS}1}$  pin, replace  $\text{EV}_{\text{DD}0}$  and  $\text{EV}_{\text{DD}1}$  with  $\text{V}_{\text{DD}}$ , or replace  $\text{EV}_{\text{SS}0}$  and  $\text{EV}_{\text{SS}1}$  with  $\text{V}_{\text{ss}}$ .**
  3. **The pins mounted depend on the product. Refer to 2.1 Port Function to 2.2.1 Functions for each product.**

## 2.3.2 Supply current characteristics

## (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products

 $(T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.6 \text{ V} \leq EV_{DD0} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{ss} = EV_{ss0} = 0 \text{ V}$ ) (1/2)

Parameter	Symbol	Conditions				MIN.	TYP.	MAX.	Unit
Supply current <sup>Note 1</sup>	$I_{DD1}$	Operating mode HS (high-speed main) mode <sup>Note 5</sup>	$f_{IH} = 32 \text{ MHz}$ <sup>Note 3</sup>	Basic operation	$V_{DD} = 5.0 \text{ V}$		2.1		mA
					$V_{DD} = 3.0 \text{ V}$		2.1		mA
			$f_{IH} = 24 \text{ MHz}$ <sup>Note 3</sup>	Normal operation	$V_{DD} = 5.0 \text{ V}$		4.6	7.0	mA
					$V_{DD} = 3.0 \text{ V}$		4.6	7.0	mA
			$f_{IH} = 16 \text{ MHz}$ <sup>Note 3</sup>	Normal operation	$V_{DD} = 5.0 \text{ V}$		2.7	4.0	mA
					$V_{DD} = 3.0 \text{ V}$		2.7	4.0	mA
		LS (low-speed main) mode <sup>Note 5</sup>	$f_{IH} = 8 \text{ MHz}$ <sup>Note 3</sup>	Normal operation	$V_{DD} = 3.0 \text{ V}$		1.2	1.8	mA
					$V_{DD} = 2.0 \text{ V}$		1.2	1.8	mA
		LV (low-voltage main) mode <sup>Note 5</sup>	$f_{IH} = 4 \text{ MHz}$ <sup>Note 3</sup>	Normal operation	$V_{DD} = 3.0 \text{ V}$		1.2	1.7	mA
					$V_{DD} = 2.0 \text{ V}$		1.2	1.7	mA
		HS (high-speed main) mode <sup>Note 5</sup>	$f_{MX} = 20 \text{ MHz}$ <sup>Note 2</sup> , $V_{DD} = 5.0 \text{ V}$	Normal operation	Square wave input		3.0	4.6	mA
					Resonator connection		3.2	4.8	mA
			$f_{MX} = 20 \text{ MHz}$ <sup>Note 2</sup> , $V_{DD} = 3.0 \text{ V}$	Normal operation	Square wave input		3.0	4.6	mA
					Resonator connection		3.2	4.8	mA
			$f_{MX} = 10 \text{ MHz}$ <sup>Note 2</sup> , $V_{DD} = 5.0 \text{ V}$	Normal operation	Square wave input		1.9	2.7	mA
					Resonator connection		1.9	2.7	mA
			$f_{MX} = 10 \text{ MHz}$ <sup>Note 2</sup> , $V_{DD} = 3.0 \text{ V}$	Normal operation	Square wave input		1.9	2.7	mA
					Resonator connection		1.9	2.7	mA
		LS (low-speed main) mode <sup>Note 5</sup>	$f_{MX} = 8 \text{ MHz}$ <sup>Note 2</sup> , $V_{DD} = 3.0 \text{ V}$	Normal operation	Square wave input		1.1	1.7	mA
					Resonator connection		1.1	1.7	mA
			$f_{MX} = 8 \text{ MHz}$ <sup>Note 2</sup> , $V_{DD} = 2.0 \text{ V}$	Normal operation	Square wave input		1.1	1.7	mA
					Resonator connection		1.1	1.7	mA
		Subsystem clock operation	$f_{SUB} = 32.768 \text{ kHz}$ <sup>Note 4</sup> $T_A = -40^\circ\text{C}$	Normal operation	Square wave input		4.1	4.9	$\mu\text{A}$
					Resonator connection		4.2	5.0	$\mu\text{A}$
			$f_{SUB} = 32.768 \text{ kHz}$ <sup>Note 4</sup> $T_A = +25^\circ\text{C}$	Normal operation	Square wave input		4.1	4.9	$\mu\text{A}$
					Resonator connection		4.2	5.0	$\mu\text{A}$
			$f_{SUB} = 32.768 \text{ kHz}$ <sup>Note 4</sup> $T_A = +50^\circ\text{C}$	Normal operation	Square wave input		4.2	5.5	$\mu\text{A}$
					Resonator connection		4.3	5.6	$\mu\text{A}$
			$f_{SUB} = 32.768 \text{ kHz}$ <sup>Note 4</sup> $T_A = +70^\circ\text{C}$	Normal operation	Square wave input		4.3	6.3	$\mu\text{A}$
					Resonator connection		4.4	6.4	$\mu\text{A}$
			$f_{SUB} = 32.768 \text{ kHz}$ <sup>Note 4</sup> $T_A = +85^\circ\text{C}$	Normal operation	Square wave input		4.6	7.7	$\mu\text{A}$
					Resonator connection		4.7	7.8	$\mu\text{A}$

(Notes and Remarks are listed on the next page.)

**Notes** 1. Total current flowing into  $V_{DD}$  and  $EV_{DD0}$ , including the input leakage current flowing when the level of the input pin is fixed to  $V_{DD}$ ,  $EV_{DD0}$  or  $V_{SS}$ ,  $EV_{SS0}$ . The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.

2. When high-speed on-chip oscillator and subsystem clock are stopped.
3. When high-speed system clock and subsystem clock are stopped.
4. When high-speed on-chip oscillator and high-speed system clock are stopped. When  $\text{AMPHS1} = 1$  (Ultra-low power consumption oscillation). However, not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
5. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode:  $2.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$  @ 1 MHz to 32 MHz

$2.4 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$  @ 1 MHz to 16 MHz

LS (low-speed main) mode:  $1.8 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$  @ 1 MHz to 8 MHz

LV (low-voltage main) mode:  $1.6 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$  @ 1 MHz to 4 MHz

**Remarks** 1.  $f_{MX}$ : High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)

2.  $f_{IH}$ : High-speed on-chip oscillator clock frequency

3.  $f_{SUB}$ : Subsystem clock frequency (XT1 clock oscillation frequency)

4. Except subsystem clock operation, temperature condition of the TYP. value is  $T_A = 25^\circ\text{C}$

**Note** The following conditions are required for low voltage interface when  $\text{EV}_{\text{DD}0} < \text{V}_{\text{DD}}$

$1.8 \text{ V} \leq \text{EV}_{\text{DD}0} < 2.7 \text{ V}$  : MIN. 125 ns

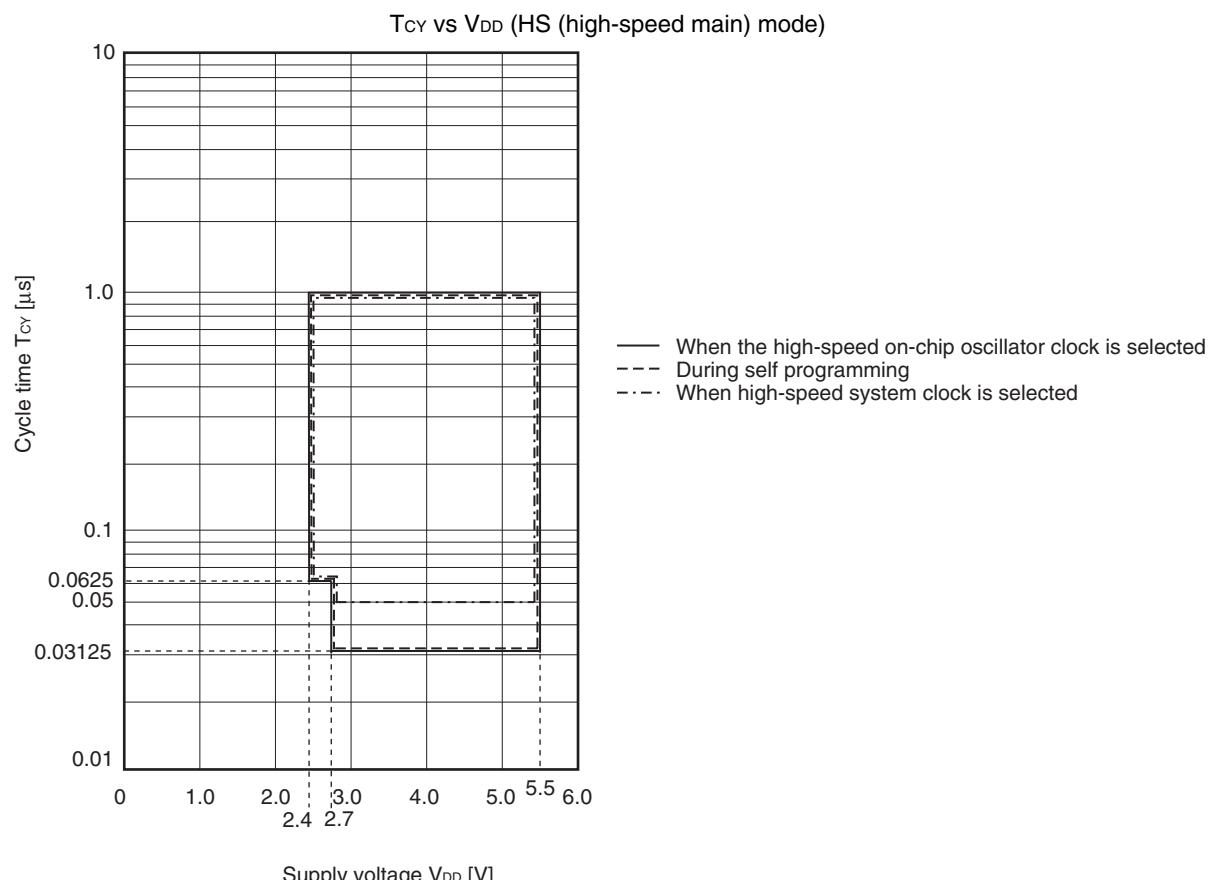
$1.6 \text{ V} \leq \text{EV}_{\text{DD}0} < 1.8 \text{ V}$  : MIN. 250 ns

**Remark**  $f_{\text{MCK}}$ : Timer array unit operation clock frequency

(Operation clock to be set by the CKSmn0, CKSmn1 bits of timer mode register mn (TMRmn)).

m: Unit number (m = 0, 1), n: Channel number (n = 0 to 7))

#### Minimum Instruction Execution Time during Main System Clock Operation



(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output)  
(3/3)

( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.8 \text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0 \text{ V}$ )

Parameter	Symbol	Conditions	HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Slp setup time (to SCKp $\downarrow$ ) <sup>Note 1</sup>	tsIK1	4.0 V $\leq$ EV <sub>DD0</sub> $\leq$ 5.5 V, 2.7 V $\leq$ V <sub>b</sub> $\leq$ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 k $\Omega$	44		110		110		ns
		2.7 V $\leq$ EV <sub>DD0</sub> < 4.0 V, 2.3 V $\leq$ V <sub>b</sub> $\leq$ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 k $\Omega$	44		110		110		ns
		1.8 V $\leq$ EV <sub>DD0</sub> < 3.3 V, 1.6 V $\leq$ V <sub>b</sub> $\leq$ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 k $\Omega$	110		110		110		ns
Slp hold time (from SCKp $\downarrow$ ) <sup>Note 1</sup>	tKS11	4.0 V $\leq$ EV <sub>DD0</sub> $\leq$ 5.5 V, 2.7 V $\leq$ V <sub>b</sub> $\leq$ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 k $\Omega$	19		19		19		ns
		2.7 V $\leq$ EV <sub>DD0</sub> < 4.0 V, 2.3 V $\leq$ V <sub>b</sub> $\leq$ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 k $\Omega$	19		19		19		ns
		1.8 V $\leq$ EV <sub>DD0</sub> < 3.3 V, 1.6 V $\leq$ V <sub>b</sub> $\leq$ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 k $\Omega$	19		19		19		ns
Delay time from SCKp $\uparrow$ to SO <sub>p</sub> output <sup>Note 1</sup>	tKS01	4.0 V $\leq$ EV <sub>DD0</sub> $\leq$ 5.5 V, 2.7 V $\leq$ V <sub>b</sub> $\leq$ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 k $\Omega$		25		25		25	ns
		2.7 V $\leq$ EV <sub>DD0</sub> < 4.0 V, 2.3 V $\leq$ V <sub>b</sub> $\leq$ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 k $\Omega$		25		25		25	ns
		1.8 V $\leq$ EV <sub>DD0</sub> < 3.3 V, 1.6 V $\leq$ V <sub>b</sub> $\leq$ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 k $\Omega$		25		25		25	ns

Notes 1. When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

2. Use it with EV<sub>DD0</sub>  $\geq$  V<sub>b</sub>.

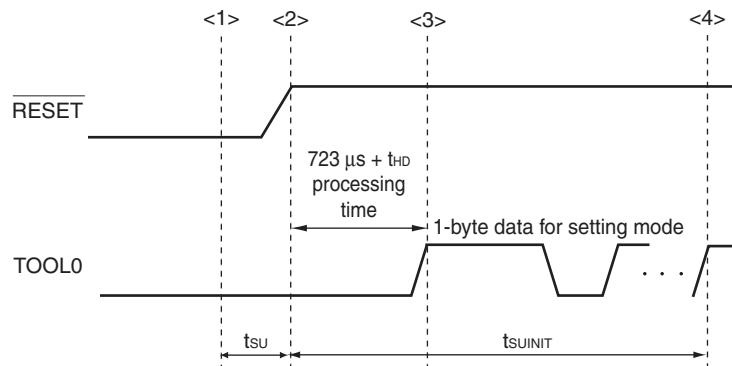
Caution Select the TTL input buffer for the Slp pin and the N-ch open drain output (V<sub>DD</sub> tolerance (When 20- to 52-pin products)/EV<sub>DD</sub> tolerance (When 64- to 128-pin products)) mode for the SO<sub>p</sub> pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the next page.)

### 2.10 Timing of Entry to Flash Memory Programming Modes

( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.8 \text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = EV_{SS0} = EV_{SS1} = 0 \text{ V}$ )

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Time to complete the communication for the initial setting after the external reset is released	$t_{SUINIT}$	POR and LVD reset must be released before the external reset is released.			100	ms
Time to release the external reset after the TOOL0 pin is set to the low level	$ts_u$	POR and LVD reset must be released before the external reset is released.	10			$\mu\text{s}$
Time to hold the TOOL0 pin at the low level after the external reset is released (excluding the processing time of the firmware to control the flash memory)	$t_{HD}$	POR and LVD reset must be released before the external reset is released.	1			ms



- <1> The low level is input to the TOOL0 pin.
- <2> The external reset is released (POR and LVD reset must be released before the external reset is released.).
- <3> The TOOL0 pin is set to the high level.
- <4> Setting of the flash memory programming mode by UART reception and complete the baud rate setting.

**Remark**  $t_{SUINIT}$ : Communication for the initial setting must be completed within 100 ms after the external reset is released during this period.

$ts_u$ : Time to release the external reset after the TOOL0 pin is set to the low level

$t_{HD}$ : Time to hold the TOOL0 pin at the low level after the external reset is released (excluding the processing time of the firmware to control the flash memory)

(TA = -40 to +105°C, 2.4 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V) (4/5)

Items	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output voltage, high	V <sub>OH1</sub>	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OH1</sub> = -3.0 mA	EV <sub>DD0</sub> – 0.7		V
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OH1</sub> = -2.0 mA	EV <sub>DD0</sub> – 0.6		V
			2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OH1</sub> = -1.5 mA	EV <sub>DD0</sub> – 0.5		V
	V <sub>OH2</sub>	P20 to P27, P150 to P156	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V, I <sub>OH2</sub> = -100 μA	V <sub>DD</sub> – 0.5		V
Output voltage, low	V <sub>OL1</sub>	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 8.5 mA		0.7	V
			4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 3.0 mA		0.6	V
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 1.5 mA		0.4	V
			2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL1</sub> = 0.6 mA		0.4	V
	V <sub>OL2</sub>	P20 to P27, P150 to P156	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V, I <sub>OL2</sub> = 400 μA		0.4	V
	V <sub>OL3</sub>	P60 to P63	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 15.0 mA		2.0	V
			4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 5.0 mA		0.4	V
			2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 3.0 mA		0.4	V
			2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, I <sub>OL3</sub> = 2.0 mA		0.4	V

**Caution** P00, P02 to P04, P10 to P15, P17, P43 to P45, P50, P52 to P55, P71, P74, P80 to P82, P96, and P142 to P144 do not output high level in N-ch open-drain mode.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

## (2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output)

(TA = -40 to +105°C, 2.4 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions		HS (high-speed main) Mode		Unit
				MIN.	MAX.	
SCKp cycle time	t <sub>KCY1</sub>	t <sub>KCY1</sub> ≥ 4/f <sub>CLK</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	250		ns
			2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	500		ns
SCKp high-/low-level width	t <sub>KH1</sub> , t <sub>KL1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		t <sub>KCY1</sub> /2 – 24		ns
		2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		t <sub>KCY1</sub> /2 – 36		ns
		2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		t <sub>KCY1</sub> /2 – 76		ns
Slp setup time (to SCKp↑) <sup>Note 1</sup>	t <sub>SIK1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		66		ns
		2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		66		ns
		2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		113		ns
Slp hold time (from SCKp↑) <sup>Note 2</sup>	t <sub>SKI1</sub>			38		ns
Delay time from SCKp↓ to SOp output <sup>Note 3</sup>	t <sub>KSO1</sub>	C = 30 pF <sup>Note 4</sup>			50	ns

- Notes**
- When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp setup time becomes “to SCKp↓” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp hold time becomes “from SCKp↓” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes “from SCKp↑” when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - C is the load capacitance of the SCKp and SOp output lines.

**Caution** Select the normal input buffer for the Slp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

- Remarks**
- p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3),  
g: PIM and POM numbers (g = 0, 1, 4, 5, 8, 14)
  - f<sub>MCK</sub>: Serial array unit operation clock frequency  
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

## (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2)

(TA = -40 to +105°C, 2.4 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions		HS (high-speed main) Mode	Unit
		MIN.	MAX.		
Transfer rate	Reception	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V	Theoretical value of the maximum transfer rate f <sub>CLK</sub> = 32 MHz, f <sub>MCK</sub> = f <sub>CLK</sub>	f <sub>MCK</sub> /12 <sup>Note 1</sup>	bps
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V	Theoretical value of the maximum transfer rate f <sub>CLK</sub> = 32 MHz, f <sub>MCK</sub> = f <sub>CLK</sub>	f <sub>MCK</sub> /12 <sup>Note 1</sup>	Mbps
		2.4 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V	Theoretical value of the maximum transfer rate f <sub>CLK</sub> = 32 MHz, f <sub>MCK</sub> = f <sub>CLK</sub>	f <sub>MCK</sub> /12 <sup>Notes 1,2</sup>	bps

**Notes** 1. Transfer rate in the SNOOZE mode is 4800 bps only.

2. The following conditions are required for low voltage interface when EV<sub>DD0</sub> < V<sub>DD</sub>.  
2.4 V ≤ EV<sub>DD0</sub> < 2.7 V : MAX. 1.3 Mbps

**Caution** Select the TTL input buffer for the RxDq pin and the N-ch open drain output (V<sub>DD</sub> tolerance (for the 20- to 52-pin products)/EV<sub>DD</sub> tolerance (for the 64- to 100-pin products)) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

**Remarks** 1. V<sub>b</sub>[V]: Communication line voltage

2. q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)

3. f<sub>MCK</sub>: Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

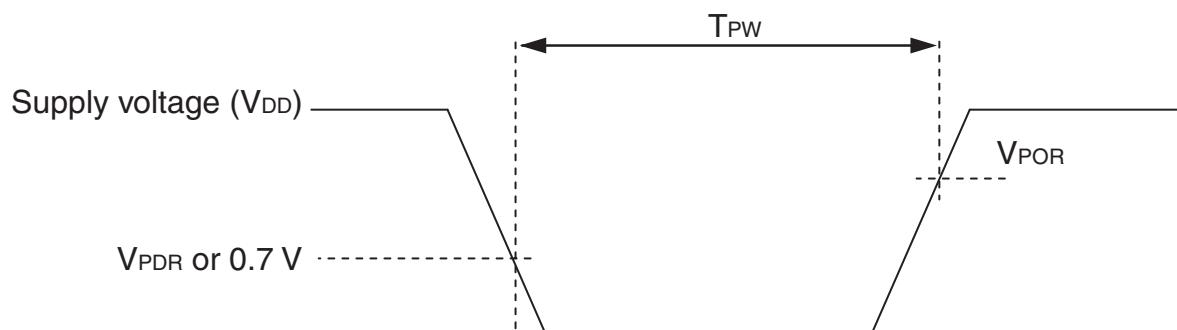
4. UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.

### 3.6.3 POR circuit characteristics

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $V_{SS} = 0$  V)

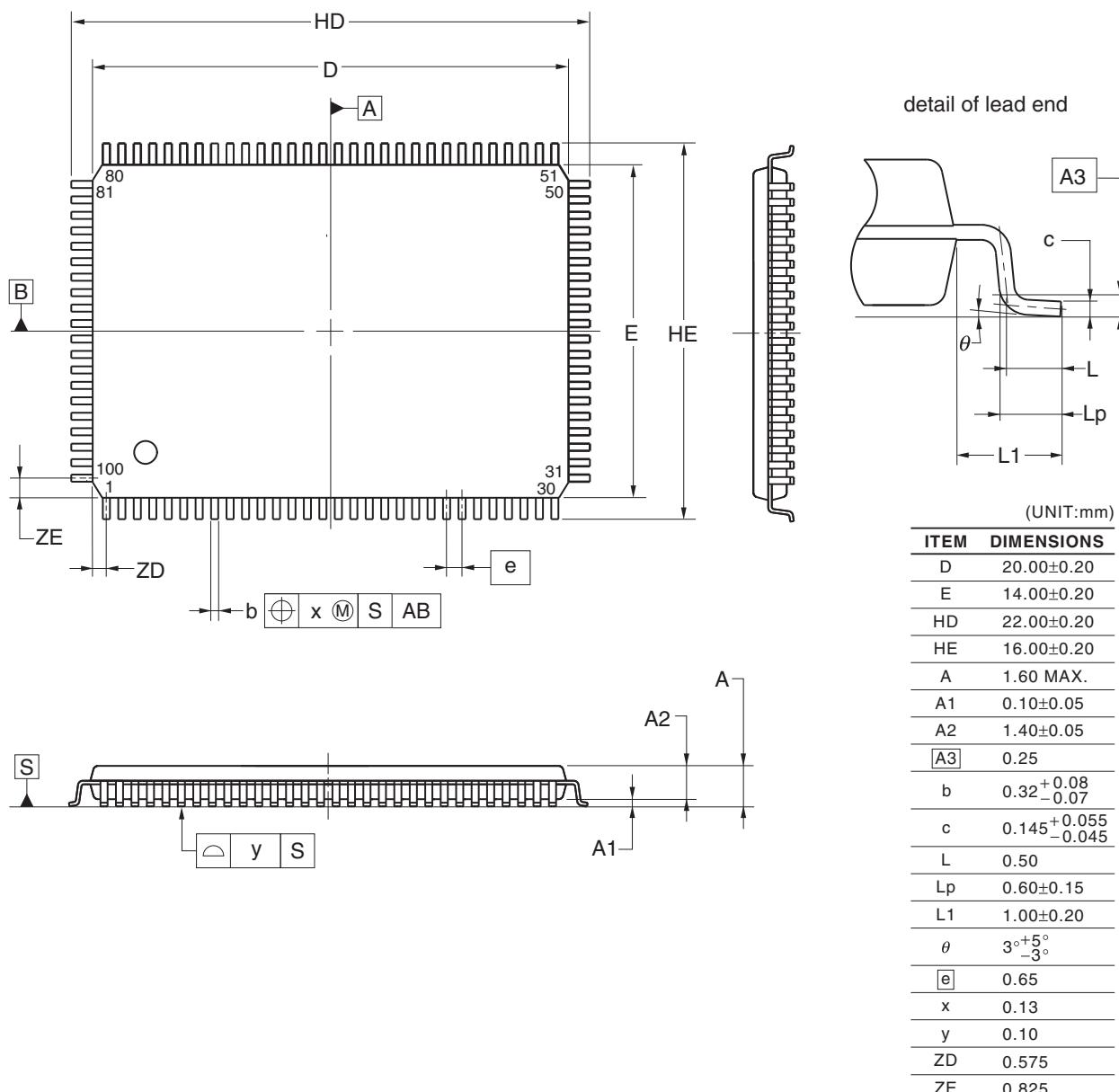
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection voltage	$V_{POR}$	Power supply rise time	1.45	1.51	1.57	V
	$V_{PDR}$	Power supply fall time	1.44	1.50	1.56	V
Minimum pulse width	$T_{PW}$		300			$\mu\text{s}$

**Note** Minimum time required for a POR reset when  $V_{DD}$  exceeds below  $V_{PDR}$ . This is also the minimum time required for a POR reset from when  $V_{DD}$  exceeds below 0.7 V to when  $V_{DD}$  exceeds  $V_{POR}$  while STOP mode is entered or the main system clock is stopped through setting bit 0 (HIOSTOP) and bit 7 (MSTOP) in the clock operation status control register (CSC).



R5F100PFAFA, R5F100PGAFA, R5F100PHAFA, R5F100PJAFA, R5F100PKAFA, R5F100PLAFA  
 R5F101PFAFA, R5F101PGAFA, R5F101PHAFA, R5F101PJAFA, R5F101PKAFA, R5F101PLAFA  
 R5F100PFDFA, R5F100PGDFA, R5F100PHDFA, R5F100PJ DFA, R5F100PK DFA, R5F100PL DFA  
 R5F101PFDFA, R5F101PGDFA, R5F101PHDFA, R5F101PJ DFA, R5F101PK DFA, R5F101PL DFA  
 R5F100PFGFA, R5F100PGGFA, R5F100PHGFA, R5F100PJGFA

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LQFP100-14x20-0.65	PLQP0100JC-A	P100GF-65-GBN-1	0.92



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		118	Modification of table and note in 2.6.3 POR circuit characteristics
		119	Modification of table in 2.6.4 LVD circuit characteristics
		120	Modification of table of LVD Detection Voltage of Interrupt & Reset Mode
		120	Renamed to 2.6.5 Power supply voltage rising slope characteristics
		122	Modification of table, figure, and remark in 2.10 Timing Specs for Switching Flash Memory Programming Modes
		123	Modification of caution 1 and description
		124	Modification of table and remark 3 in Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ )
		126	Modification of table, note, caution, and remark in 3.2.1 X1, XT1 oscillator characteristics
		126	Modification of table in 3.2.2 On-chip oscillator characteristics
		127	Modification of note 3 in 3.3.1 Pin characteristics (1/5)
		128	Modification of note 3 in 3.3.1 Pin characteristics (2/5)
		133	Modification of notes 1 and 4 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products (1/2)
		135	Modification of notes 1, 5, and 6 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products (2/2)
		137	Modification of notes 1 and 4 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (1/2)
		139	Modification of notes 1, 5, and 6 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (2/2)
		140	Modification of (3) Peripheral Functions (Common to all products)
		142	Modification of table in 3.4 AC Characteristics
		143	Addition of Minimum Instruction Execution Time during Main System Clock Operation
		143	Modification of figure of AC Timing Test Points
		143	Modification of figure of External System Clock Timing
		145	Modification of figure of AC Timing Test Points
		145	Modification of description, note 1, and caution in (1) During communication at same potential (UART mode)
		146	Modification of description in (2) During communication at same potential (CSI mode)
		147	Modification of description in (3) During communication at same potential (CSI mode)
		149	Modification of table, note 1, and caution in (4) During communication at same potential (simplified I <sup>2</sup> C mode)
		151	Modification of table, note 1, and caution in (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2)
		152 to 154	Modification of table, notes 2 to 6, caution, and remarks 1 to 4 in (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (2/2)
		155	Modification of table in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (1/3)
		156	Modification of table and caution in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (2/3)
		157, 158	Modification of table, caution, and remarks 3 and 4 in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (3/3)
		160, 161	Modification of table and caution in (7) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode)